

IEEE Standard for Ethernet

Amendment 10: Media Access Control Parameters, Physical Layers, and Management Parameters for 200 Gb/s and 400 Gb/s Operation

IEEE Computer Society

Sponsored by the
LAN/MAN Standards Committee

IEEE
3 Park Avenue
New York, NY 10016-5997
USA

IEEE Std 802.3bs™-2017
(Amendment to
IEEE Std 802.3™-2015
as amended by
IEEE Std 802.3bw™-2015,
IEEE Std 802.3by™-2016,
IEEE Std 802.3bq™-2016,
IEEE Std 802.3bp™-2016,
IEEE Std 802.3br™-2016,
IEEE Std 802.3bn™-2016,
IEEE Std 802.3bz™-2016,
IEEE Std 802.3bu™-2016,
IEEE Std 802.3bv™-2017, and
IEEE Std 802.3-2015/Cor 1-2017)

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IEEE Std 802.3-2015/Cor 1-2017)

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LAN/MAN Standards Committee
of the
IEEE Computer Society

Approved 6 December 2017
of the
IEEE-SA Standards Board

Abstract: Clause 116 through Clause 124 and Annex 119A through Annex 120E are added by this amendment to IEEE Std 802.3-2015. This amendment includes IEEE 802.3 Media Access Control (MAC) parameters, Physical Layer specifications, and management parameters for the transfer of IEEE 802.3 format frames at 200 Gb/s and 400 Gb/s.

Keywords: 200 Gb/s Ethernet, 200GAUI-4, 200GAUI-8, 200GBASE-DR4, 200GBASE-FR4, 200GBASE-LR4, 200GBASE-R, 200GMII, 200GXS, 400 Gb/s Ethernet, 400GAUI-8, 400GAUI-16, 400GBASE-DR4, 400GBASE-FR8, 400GBASE-LR8, 400GBASE-SR16, 400GBASE-R, 400GMII, 400GXS, EEE, Energy Efficient Ethernet, Ethernet, FEC, forward error correction, IEEE 802.3™, IEEE 802.3bs™, MMF, PAM4, Physical Medium Dependent sublayer, PMD, SMF

The Institute of Electrical and Electronics Engineers, Inc.
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PDF: ISBN 978-1-5044-4450-7 STD22871
Print: ISBN 978-1-5044-4451-4 STDPD22871

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Introduction

This introduction is not part of IEEE Std 802.3bs-2017, IEEE Standard for Ethernet—Amendment 10: Media Access Control Parameters, Physical Layers, and Management Parameters for 200 Gb/s and 400 Gb/s Operation.

IEEE Std 802.3™ was first published in 1985. Since the initial publication, many projects have added functionality or provided maintenance updates to the specifications and text included in the standard. Each IEEE 802.3 project/amendment is identified with a suffix (e.g., IEEE Std 802.3ba™-2010).

The half duplex Media Access Control (MAC) protocol specified in IEEE Std 802.3-1985 is Carrier Sense Multiple Access with Collision Detection (CSMA/CD). This MAC protocol was key to the experimental Ethernet developed at Xerox Palo Alto Research Center, which had a 2.94 Mb/s data rate. Ethernet at 10 Mb/s was jointly released as a public specification by Digital Equipment Corporation (DEC), Intel, and Xerox in 1980. Ethernet at 10 Mb/s was approved as an IEEE standard by the IEEE Standards Board in 1983 and subsequently published in 1985 as IEEE Std 802.3-1985. Since 1985, new media options, new speeds of operation, and new capabilities have been added to IEEE Std 802.3. A full duplex MAC protocol was added in 1997.

Some of the major additions to IEEE Std 802.3 are identified in the marketplace with their project number. This is most common for projects adding higher speeds of operation or new protocols. For example, IEEE Std 802.3u™ added 100 Mb/s operation (also called Fast Ethernet), IEEE Std 802.3z added 1000 Mb/s operation (also called Gigabit Ethernet), IEEE Std 802.3ae added 10 Gb/s operation (also called 10 Gigabit Ethernet), IEEE Std 802.3ah™ specified access network Ethernet (also called Ethernet in the First Mile) and IEEE Std 802.3ba added 40 Gb/s operation (also called 40 Gigabit Ethernet) and 100 Gb/s operation (also called 100 Gigabit Ethernet). These major additions are all now included in and are superseded by IEEE Std 802.3-2015 and are not maintained as separate documents.

At the publication date of IEEE Std 802.3bs-2017, IEEE Std 802.3 is composed of the following documents:

IEEE Std 802.3-2015

Section One—Includes Clause 1 through Clause 20 and Annex A through Annex H and Annex 4A. Section One includes the specifications for 10 Mb/s operation and the MAC, frame formats and service interfaces used for all speeds of operation.

Section Two—Includes Clause 21 through Clause 33 and Annex 22A through Annex 33E. Section Two includes management attributes for multiple protocols and speed of operation as well as specifications for providing power over twisted pair cabling for multiple operational speeds. It also includes general information on 100 Mb/s operation as well as most of the 100 Mb/s Physical Layer specifications.

Section Three—Includes Clause 34 through Clause 43 and Annex 36A through Annex 43C. Section Three includes general information on 1000 Mb/s operation as well as most of the 1000 Mb/s Physical Layer specifications.

Section Four—Includes Clause 44 through Clause 55 and Annex 44A through Annex 55B. Section Four includes general information on 10 Gb/s operation as well as most of the 10 Gb/s Physical Layer specifications.

Section Five—Includes Clause 56 through Clause 77 and Annex 57A through Annex 76A. Clause 56 through Clause 67 and Clause 75 through Clause 77, as well as associated annexes, specify subscriber access and other Physical Layers and sublayers for operation from 512 kb/s to 10 Gb/s, and defines services and protocol elements that enable the exchange of IEEE Std 802.3 format frames between

stations in a subscriber access network. Clause 68 specifies a 10 Gb/s Physical Layer specification. Clause 69 through Clause 74 and associated annexes specify Ethernet operation over electrical backplanes at speeds of 1000 Mb/s and 10 Gb/s.

Section Six—Includes Clause 78 through Clause 95 and Annex 83A through Annex 93C. Clause 78 specifies Energy-Efficient Ethernet. Clause 79 specifies IEEE 802.3 Organizationally Specific Link Layer Discovery Protocol (LLDP) type, length, and value (TLV) information elements. Clause 80 through Clause 95 and associated annexes includes general information on 40 Gb/s and 100 Gb/s operation as well the 40 Gb/s and 100 Gb/s Physical Layer specifications. Clause 90 specifies Ethernet support for time synchronization protocols.

IEEE Std 802.3bw™-2015

Amendment 1—This amendment includes changes to IEEE Std 802.3-2015 and adds Clause 96. This amendment adds 100 Mb/s Physical Layer (PHY) specifications and management parameters for operation on a single balanced twisted-pair copper cable.

IEEE Std 802.3by™-2016

Amendment 2—This amendment includes changes to IEEE Std 802.3-2015 and adds Clause 105 through Clause 112, Annex 109A, Annex 109B, Annex 109C, Annex 110A, Annex 110B, and Annex 110C. This amendment adds MAC parameters, Physical Layers, and management parameters for the transfer of IEEE 802.3 format frames at 25 Gb/s.

IEEE Std 802.3bq™-2016

Amendment 3—This amendment includes changes to IEEE Std 802.3-2015 and adds Clause 113 and Annex 113A. This amendment adds new Physical Layers for 25 Gb/s and 40 Gb/s operation over balanced twisted-pair structured cabling systems.

IEEE Std 802.3bp™-2016

Amendment 4—This amendment includes changes to IEEE Std 802.3-2015 and adds Clause 97 and Clause 98. This amendment adds point-to-point 1 Gb/s Physical Layer (PHY) specifications and management parameters for operation on a single balanced twisted-pair copper cable in automotive and other applications not utilizing the structured wiring plant.

IEEE Std 802.3br™-2016

Amendment 5—This amendment includes changes to IEEE Std 802.3-2015 and adds Clause 99. This amendment adds a MAC Merge sublayer and a MAC Merge Service Interface to support for Interspersing Express Traffic over a single link.

IEEE Std 802.3bn™-2016

Amendment 6—This amendment adds the Physical Layer specifications and management parameters for symmetric and/or asymmetric operation of up to 10 Gb/s on point-to-multipoint Radio Frequency (RF) distribution plants comprising either amplified or passive coaxial media. It also extends the operation of Ethernet Passive Optical Networks (EPON) protocols, such as Multipoint Control Protocol (MPCP) and Operation Administration and Management (OAM).

IEEE Std 802.3bz™-2016

Amendment 7—This amendment includes changes to IEEE Std 802.3-2015 and adds Clause 125 and Clause 126. This amendment adds new rates of 2.5 Gb/s and 5 Gb/s and new Physical Layers for operation at 2.5 Gb/s and 5 Gb/s over balanced twisted-pair structured cabling systems.

IEEE Std 802.3bu™-2016

Amendment 8—This amendment includes changes to IEEE Std 802.3-2015 to define a methodology for the provision of power via a single twisted pair to connected Data Terminal Equipment (DTE) with IEEE 802.3 single twisted-pair interfaces.

IEEE Std 802.3bv™-2017

Amendment 9—This amendment includes changes to IEEE Std 802.3-2015 and adds Clause 115 and Annex 115A. This amendment adds point-to-point 1000 Mb/s Physical Layer (PHY) specifications and management parameters for operation on duplex plastic optical fiber (POF) targeting use in automotive, industrial, home-network, and other applications.

IEEE Std 802.3™-2015/Cor 1-2017

This corrigendum clarifies which lane of the media dependent interface (MDI) of a multi-lane Physical Layer entity (PHY) is used as the timestamping reference point.

IEEE Std 802.3bs™-2017

Amendment 10—This amendment includes changes to IEEE Std 802.3-2015 and adds Clause 116 through Clause 124 and Annex 119A through Annex 120E. This amendment adds MAC parameters, Physical Layers, and management parameters for the transfer of IEEE 802.3 format frames at 200 Gb/s and 400 Gb/s.

A companion document IEEE Std 802.3.1 describes Ethernet management information base (MIB) modules for use with the Simple Network Management Protocol (SNMP). IEEE Std 802.3.1 is updated to add management capability for enhancements to IEEE Std 802.3 after approval of the enhancements.

IEEE Std 802.3 will continue to evolve. New Ethernet capabilities are anticipated to be added within the next few years as amendments to this standard.

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